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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Active
Number of LABs/CLBs	8500
Number of Logic Elements/Cells	68000
Total RAM Bits	1056768
Number of I/O	583
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-70e-5fn900i

July 2012

Data Sheet DS1006

Features

- **High Logic Density for System Integration**
 - 6K to 95K LUTs
 - 90 to 583 I/Os
- **Embedded SERDES (LatticeECP2M Only)**
 - Data Rates 250 Mbps to 3.125 Gbps
 - Up to 16 channels per device
 - PCI Express, Ethernet (1GbE, SGMII), OBSAI, CPRI and Serial RapidIO.
- **sysDSP™ Block**
 - 3 to 42 blocks for high performance multiply and accumulate
 - Each block supports
 - One 36x36, four 18x18 or eight 9x9 multipliers
- **Flexible Memory Resources**
 - 55Kbits to 530Kbits sysMEM™ Embedded Block RAM (EBR)
 - 18Kbit block
 - Single, pseudo dual and true dual port
 - Byte Enable Mode support
 - 12K to 202Kbits distributed RAM
 - Single port and pseudo dual port
- **sysCLOCK Analog PLLs and DLLs**
 - Two GPLLS and up to six SPLLLs per device
 - Clock multiply, divide, phase & delay adjust
 - Dynamic PLL adjustment
 - Two general purpose DLLs per device

- **Pre-Engineered Source Synchronous I/O**
 - DDR registers in I/O cells
 - Dedicated gearing logic
 - Source synchronous standards support
 - SPI4.2, SFI4 (DDR Mode), XGMII
 - High Speed ADC/DAC devices
 - Dedicated DDR and DDR2 memory support
 - DDR1: 400 (200MHz) / DDR2: 533 (266MHz)
 - Dedicated DQS support
- **Programmable sysI/O™ Buffer Supports Wide Range Of Interfaces**
 - LVTTL and LVCMSO 33/25/18/15/12
 - SSTL 3/2/18 I, II
 - HSTL15 I and HSTL18 I, II
 - PCI and Differential HSTL, SSTL
 - LVDS, RSDS, Bus-LVDS, MLVDS, LVPECL
- **Flexible Device Configuration**
 - 1149.1 Boundary Scan compliant
 - Dedicated bank for configuration I/Os
 - SPI boot flash interface
 - Dual boot images supported
 - TransFR™ I/O for simple field updates
 - Soft Error Detect macro embedded
- **Optional Bitstream Encryption (LatticeECP2/M “S” Versions Only)**
- **System Level Support**
 - ispTRACY™ internal logic analyzer capability
 - On-chip oscillator for initialization & general use
 - 1.2V power supply

Table 1-1. LatticeECP2 (Including “S-Series”) Family Selection

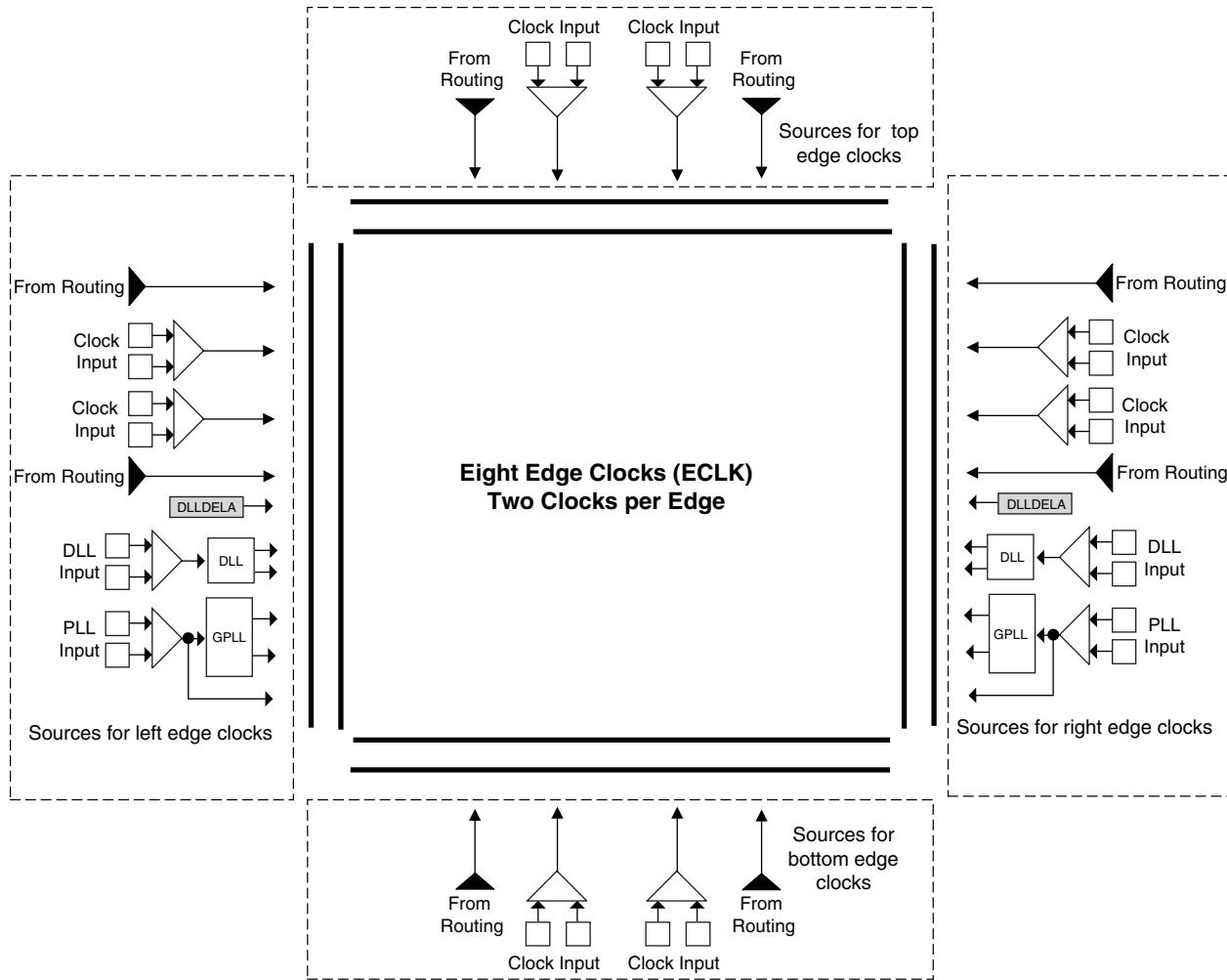
Device	ECP2-6	ECP2-12	ECP2-20	ECP2-35	ECP2-50	ECP2-70
LUTs (K)	6	12	21	32	48	68
Distributed RAM (Kbits)	12	24	42	64	96	136
EBR SRAM (Kbits)	55	221	276	332	387	1032
EBR SRAM Blocks	3	12	15	18	21	60
sysDSP Blocks	3	6	7	8	18	22
18x18 Multipliers	12	24	28	32	72	88
GPLL + SPLLL + DLL	2+0+2	2+0+2	2+0+2	2+0+2	2+2+2	2+4+2
Maximum Available I/O	190	297	402	450	500	583
Packages and I/O Combinations						
144-pin TQFP (20 x 20 mm)	90	93				
208-pin PQFP (28 x 28 mm)		131	131			
256-ball fpBGA (17 x 17 mm)	190	193	193			
484-ball fpBGA (23 x 23 mm)		297	331	331	339	
672-ball fpBGA (27 x 27 mm)			402	450	500	500
900-ball fpBGA (31 x 31 mm)						583

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Edge Clock Sources

Edge clock resources can be driven from a variety of sources at the same edge. Edge clock resources can be driven from adjacent edge clock PIOs, primary clock PIOs, PLLs/DLLs and clock dividers as shown in Figure 2-12.

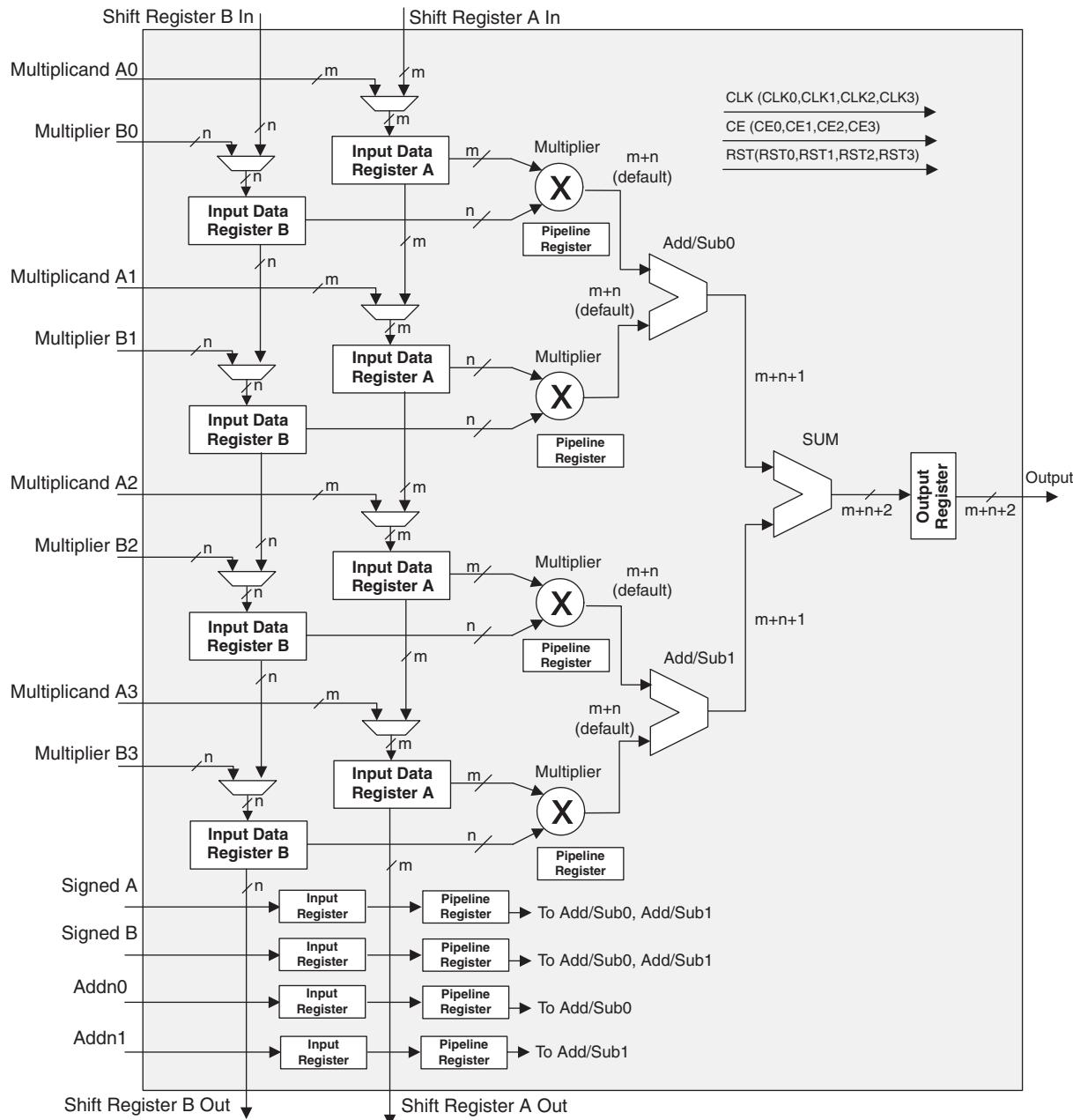
Figure 2-12. Edge Clock Sources



MULTADDSSUBSUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-26 shows the MULTADDSSUBSUM sysDSP element.

Figure 2-26. MULTADDSSUBSUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3)

LatticeECP2 Initialization Supply Current^{1, 2, 3, 4}

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ^{5, 6, 7}	Units
I_{CC}	Core Power Supply Current	ECP2-6	34	mA
		ECP2-12	54	mA
		ECP2-20	82	mA
		ECP2-35	135	mA
		ECP2-50	187	mA
		ECP2-70	267	mA
I_{CCAU}	Auxiliary Power Supply Current	ECP2-6	30	mA
		ECP2-12	30	mA
		ECP2-20	30	mA
		ECP2-35	30	mA
		ECP2-50	30	mA
		ECP2-70	30	mA
I_{CCPLL}	GPLL Power Supply Current (per GPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.
2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
4. Frequency 0MHz.
5. $T_J = 25^\circ\text{C}$, power supplies at nominal voltage.
6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.
7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
t_{SU_DEPLLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
t_{H_DEPLLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns

DDR I/O Pin Parameters²

t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR}	DDR Clock Frequency ⁶	ECP2/M	95	200	95	166	95	133	MHz

DDR2 I/O Pin Parameters³

t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

Table 3-9. Channel Output Jitter - x20 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.27	0.51	UI, p-p
Total	3.125 Gbps	—	0.35	0.59	UI, p-p
Deterministic	2.5 Gbps	—	0.09	0.19	UI, p-p
Random	2.5 Gbps	—	0.23	0.34	UI, p-p
Total	2.5 Gbps	—	0.29	0.45	UI, p-p
Deterministic	1.25 Gbps	—	0.05	0.11	UI, p-p
Random	1.25 Gbps	—	0.16	0.22	UI, p-p
Total	1.25 Gbps	—	0.20	0.28	UI, p-p

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x20 mode.

Table 3-10. SERDES/PCS Latency Breakdown (Parallel Clock Cycle)

Item	Description	Min.	Average	Max.	Fixed	Bypass	Units
Transmit Data Latency							
T1	FPGA Bridge Transmit ²	1	3	5	—	1	word clk
T2	8b10b Encoder	—	—	—	2	1	word clk
T3	SERDES Bridge Transmit	—	—	—	2	1	word clk
T4 ³	Serializer: 8-bit mode	—	—	—	15 + Δ1	—	UI + ps
	Serializer: 10-bit mode	—	—	—	18 + Δ1	—	UI + ps
Receive Data Latency							
R1 ³	Deserializer: 8-bit mode	—	—	—	10 + Δ2	—	UI + ps
	Deserializer: 10-bit mode	—	—	—	12 + Δ2	—	UI + ps
R2	SERDES Bridge Receive	—	—	—	2	1	word clk
R3	Word Alignment	3.1	—	4	—	0	word clk
R4	8b10b Decoder	—	—	—	1	1	word clk
R5	Clock Tolerance Compensation	7	15	23	—	1	word clk
R6	FPGA Bridge Receive ²	1	3	5	—	1	word clk

1. PCS internal parallel clock. This clock rate is the same as rxfullclk.

2. FPGA Bridge latency varies by the upsample/downsample FIFO read/write. The numbers given are for the 8b10b interface. The depth of the downsample/upsample FIFO is 4. The earliest read can be done after the write clock cycle (one clock) in downsample FIFO. The latest read will be done after the FIFO is full (4 + 1 = 5). For the 16b20b interface, the numbers are doubled: min. = 2, max. = 10. This latency depends on the internal FIFO flag operation.

3. Δ1 = -245ps, Δ2 = 700ps

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	L11	PB61B	4	BDQ60	C
T13	T13	PB62A	4	BDQ60	T
R13	R13	PB63A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
T14	T14	PB62B	4	BDQ60	C
P13	P13	PB63B	4	BDQ60	C
GND	GND	GNDIO4	-		
N12	N12	PB64A	4	VREF2_4/BDQ60	T
M12	M12	PB64B	4	VREF1_4/BDQ60	C
R15	R15	CFG2	8		
N14	N14	CFG1	8		
N13	N13	PROGRAMN	8		
N15	N15	CFG0	8		
P15	P15	PR44B	8	WRITEN	C
L12	L12	INITN	8		
N16	N16	PR43B	8	CSN	C
GND	GND	GNDIO8	-		
R14	R14	CCLK	8		
P14	P14	PR44A	8	CS1N	T
M13	M13	DONE	8		
R16	R16	PR42B	8	D1	C
VCCIO	VCCIO	VCCIO8	8		
M16	M16	PR43A	8	D0/SPIFASTN	T
P16	P16	PR42A	8	D2	T
L15	L15	PR41B	8	D3	C
GND	GND	GNDIO8	-		
L14	L14	PR40A	8	D6	T
L16	L16	PR41A	8	D4	T
L10	L10	PR39B	8	D7/SPID0	C
L13	L13	PR40B	8	D5	C
VCCIO	VCCIO	VCCIO8	8		
K11	K11	PR39A	8	DI/CSSPI0N	T
K14	K14	PR38B	8	DOUT/CS0N	C
K13	K13	PR38A	8	BUSY/SISPI	T
GND	GND	GNDIO8	-		
K15	K15	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C
VCCIO	VCCIO	VCCIO3	3		
K16	K16	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T
GND	GND	GNDIO3	-		
J16	J16	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*
J15	J15	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*
J14	J14	RLM0_PLLCAP	3		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F19	PR5A	2		T	PR7A	2	RDQ8	T
D20	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*
F18	PR3B	2		C	PR5B	2	RDQ8	C
VCCIO	VCCIO2	2			VCCIO2	2		
C21	NC	-			PR4B	2	RDQ8	C (LVDS)*
F16	PR3A	2		T	PR5A	2	RDQ8	T
C22	NC	-			PR4A	2	RDQ8	T (LVDS)*
-	-	-			GNDIO	-		
D19	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C
B22	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T
GNDIO	GNDIO1	-			GNDIO1	-		
D18	PT53B	1		C	PT62B	1		C
C20	PT54B	1		C	PT63B	1		C
E18	PT53A	1		T	PT62A	1		T
C19	PT54A	1		T	PT63A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D17	PT51B	1		C	PT60B	1		C
B20	PT52B	1		C	PT61B	1		C
C18	PT51A	1		T	PT60A	1		T
A19	PT52A	1		T	PT61A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A18	PT49B	1		C	PT58B	1		C
A21	PT50B	1		C	PT59B	1		C
B18	PT49A	1		T	PT58A	1		T
A20	PT50A	1		T	PT59A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D16	PT47B	1		C	PT56B	1		C
G16	PT48B	1		C	PT57B	1		C
E16	PT47A	1		T	PT56A	1		T
G15	PT48A	1		T	PT57A	1		T
C17	PT46B	1		C	PT55B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT46A	1		T	PT55A	1		T
A17	PT44B	1		C	PT53B	1		C
B17	PT45B	1		C	PT54B	1		C
A16	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B16	PT45A	1		T	PT54A	1		T
E15	PT42B	1		C	PT51B	1		C
C15	PT43B	1		C	PT52B	1		C
F15	PT42A	1		T	PT51A	1		T
D15	PT43A	1		T	PT52A	1		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
N15	GND	-			GND	-			
N17	GND	-			GND	-			
P10	GND	-			GND	-			
P12	GND	-			GND	-			
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P17	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T24	GND	-			GND	-			
T3	GND	-			GND	-			
U10	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U16	GND	-			GND	-			
U17	GND	-			GND	-			
V13	GND	-			GND	-			
V14	GND	-			GND	-			
V21	GND	-			GND	-			
V6	GND	-			GND	-			
M3	NC	-			NC	-			
N6	NC	-			NC	-			
P24	NC	-			NC	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLS or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A7	PT35B	0		C	PT44B	0		C	
B7	PT35A	0		T	PT44A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F12	PT34B	0		C	PT43B	0		C	
D10	PT34A	0		T	PT43A	0		T	
H11	PT33B	0		C	PT42B	0		C	
G11	PT33A	0		T	PT42A	0		T	
GND	GNDIO0	-			GNDIO0	-			
A6	PT32B	0		C	PT41B	0		C	
B6	PT32A	0		T	PT41A	0		T	
D8	PT31B	0		C	PT40B	0		C	
C8	PT31A	0		T	PT40A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F11	PT30B	0		C	PT39B	0		C	
E10	PT30A	0		T	PT39A	0		T	
E9	PT29B	0		C	PT38B	0		C	
D9	PT29A	0		T	PT38A	0		T	
G10	PT28B	0		C	PT37B	0		C	
GND	GNDIO0	-			GNDIO0	-			
H10	PT28A	0		T	PT37A	0		T	
A5	PT27B	0		C	PT36B	0		C	
B5	PT27A	0		T	PT36A	0		T	
C7	PT26B	0		C	PT35B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
D7	PT26A	0		T	PT35A	0		T	
E8	PT25B	0		C	PT34B	0		C	
F10	PT25A	0		T	PT34A	0		T	
F8	PT24B	0		C	PT33B	0		C	
H9	PT24A	0		T	PT33A	0		T	
C5	PT23B	0		C	PT32B	0		C	
GND	GNDIO0	-			GNDIO0	-			
D5	PT23A	0		T	PT32A	0		T	
B4	PT22B	0			PT31B	0			
VCCIO	VCCIO0	0			VCCIO0	0			
GND	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
GND	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
C4	PT10B	0		C	PT10B	0		C	
GND	GNDIO0	-			GNDIO0	-			
C3	PT10A	0		T	PT10A	0		T	
A4	PT9B	0		C	PT9B	0		C	
A3	PT9A	0		T	PT9A	0		T	
B3	PT8B	0		C	PT8B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
B2	PT8A	0		T	PT8A	0		T	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L23	VCCIO2	2			VCCIO2	2			
M17	VCCIO2	2			VCCIO2	2			
M18	VCCIO2	2			VCCIO2	2			
AA23	VCCIO3	3			VCCIO3	3			
R17	VCCIO3	3			VCCIO3	3			
R18	VCCIO3	3			VCCIO3	3			
T23	VCCIO3	3			VCCIO3	3			
V20	VCCIO3	3			VCCIO3	3			
AC16	VCCIO4	4			VCCIO4	4			
AC21	VCCIO4	4			VCCIO4	4			
U15	VCCIO4	4			VCCIO4	4			
V15	VCCIO4	4			VCCIO4	4			
Y18	VCCIO4	4			VCCIO4	4			
AC11	VCCIO5	5			VCCIO5	5			
AC6	VCCIO5	5			VCCIO5	5			
U12	VCCIO5	5			VCCIO5	5			
V12	VCCIO5	5			VCCIO5	5			
Y9	VCCIO5	5			VCCIO5	5			
AA4	VCCIO6	6			VCCIO6	6			
R10	VCCIO6	6			VCCIO6	6			
R9	VCCIO6	6			VCCIO6	6			
T4	VCCIO6	6			VCCIO6	6			
V7	VCCIO6	6			VCCIO6	6			
F4	VCCIO7	7			VCCIO7	7			
J7	VCCIO7	7			VCCIO7	7			
L4	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M9	VCCIO7	7			VCCIO7	7			
AE25	VCCIO8	8			VCCIO8	8			
V18	VCCIO8	8			VCCIO8	8			
J10	VCCAUX	-			VCCAUX	-			
J11	VCCAUX	-			VCCAUX	-			
J16	VCCAUX	-			VCCAUX	-			
J17	VCCAUX	-			VCCAUX	-			
K18	VCCAUX	-			VCCAUX	-			
K9	VCCAUX	-			VCCAUX	-			
L18	VCCAUX	-			VCCAUX	-			
L9	VCCAUX	-			VCCAUX	-			
T18	VCCAUX	-			VCCAUX	-			
T9	VCCAUX	-			VCCAUX	-			
U18	VCCAUX	-			VCCAUX	-			
U9	VCCAUX	-			VCCAUX	-			
V10	VCCAUX	-			VCCAUX	-			
V11	VCCAUX	-			VCCAUX	-			
V16	VCCAUX	-			VCCAUX	-			
V17	VCCAUX	-			VCCAUX	-			

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AD2	PL90B	6	LDQ88	C (LVDS)*
AD7	PL91A	6	LDQ88	T
GND	GNDIO6	-		
AB9	PL91B	6	LDQ88	C
AD5	TCK	-		
AE7	TDI	-		
AD4	TMS	-		
AA9	TDO	-		
AD3	VCCJ	-		
AC8	PB2A	5	VREF2_5/BDQ6	T
AE8	PB2B	5	VREF1_5/BDQ6	C
AD8	PB3A	5	BDQ6	T
AF8	PB3B	5	BDQ6	C
AG7	PB4A	5	BDQ6	T
VCCIO	VCCIO5	5		
AH7	PB4B	5	BDQ6	C
AC9	PB5A	5	BDQ6	T
AE9	PB5B	5	BDQ6	C
AD9	PB6A	5	BDQS6	T
GND	GNDIO5	-		
AF9	PB6B	5	BDQ6	C
AB10	PB7A	5	BDQ6	T
AA10	PB7B	5	BDQ6	C
AJ7	PB8A	5	BDQ6	T
VCCIO	VCCIO5	5		
AK7	PB8B	5	BDQ6	C
AC10	PB9A	5	BDQ6	T
AE10	PB9B	5	BDQ6	C
AJ8	PB10A	5	BDQ6	T
GND	GNDIO5	-		
AK8	PB10B	5	BDQ6	C
AF6	PB11A	5	BDQ15	T
AF7	PB11B	5	BDQ15	C
AG5	PB12A	5	BDQ15	T
AH5	PB12B	5	BDQ15	C
AG6	PB13A	5	BDQ15	T
AH6	PB13B	5	BDQ15	C
VCCIO	VCCIO5	5		
AJ4	PB14A	5	BDQ15	T
AK4	PB14B	5	BDQ15	C
GND	GNDIO5	-		
AJ5	PB15A	5	BDQS15	T
AK5	PB15B	5	BDQ15	C

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
F19	PR11A	2	RUM0_SPLLTI_IN_A	T (LVDS)*	PR11A	2	RUM0_SPLLTI_IN_A/RDQ15	T (LVDS)*	
E18	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C	
GNDIO	GNDIO2	-			GNDIO2	-			
D18	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T	
VCCIO	VCCIO2	2			-	-			
F16	XRES	-			XRES	-			
C22	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12			
A21	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T	
B22	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12			
B21	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C	
C19	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12			
A18	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T	
A19	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12			
B18	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C	
C18	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12			
B17	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C	
C17	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12			
A17	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T	
C21	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12			
B20	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C	
C20	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12			
A20	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T	
B16	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12			
E17	URC_SQ_REFCLK_N	12		C	URC_SQ_REFCLK_N	12		C	
D17	URC_SQ_REFCLK_P	12		T	URC_SQ_REFCLK_P	12		T	
C16	URC_SQ_VCCP	12			URC_SQ_VCCP	12			
A12	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T	
C12	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12			
B12	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C	
C11	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12			
A15	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T	
C15	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12			
B15	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C	
C14	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12			
B14	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C	
A13	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12			
A14	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T	
C13	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12			
B11	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C	
B10	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12			
A11	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T	
C10	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12			

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U21	CS1N***	8		
U17	CSN***	8		
U16	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
T16	D1***	8		
T17	D2***	8		
T22	D3***	8		
GNDIO	GNDIO8	-		
R22	D4***	8		
T15	D5***	8		
R17	D6***	8		
T20	D7/SPID0***	8		
VCCIO	VCCIO8	8		
T21	DI/CSSPI0N***	8		
R21	DOUT/CS0N/CSSPI1N***	8		
R20	BUSY/SISPI***	8		
R16	RLM0_PLLCAP	3		
R18	PR65B	3	RLM0_GDLLC_FB_A	C
GNDIO	GNDIO3	-		
R19	PR65A	3	RLM0_GDLLT_FB_A	T
P22	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
P21	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
P16	PR63B	3	RLM0_GPLLC_IN_A**	C
VCCIO	VCCIO3	3		
P17	PR63A	3	RLM0_GPLLT_IN_A**	T
P20	PR62B	3	RLM0_GPLLC_FB_A	C (LVDS)*
P19	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*
GNDIO	GNDIO3	-		
VCCIO	VCCIO3	3		
P18	PR55B	3	RDQ52	C
N16	PR55A	3	RDQ52	T
GNDIO	GNDIO3	-		
N22	PR54B	3	RDQ52	C (LVDS)*
N21	PR54A	3	RDQ52	T (LVDS)*
N17	PR53B	3	RDQ52	C
N18	PR53A	3	RDQ52	T
VCCIO	VCCIO3	3		
M22	PR52B	3	RDQ52	C (LVDS)*
M21	PR52A	3	RDQS52	T (LVDS)*
M16	PR51B	3	RDQ52	C
GNDIO	GNDIO3	-		
M17	PR51A	3	RDQ52	T
M20	PR50B	3	RDQ52	C (LVDS)*

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K3	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M7	VCCIO7	7			VCCIO7	7			
N10	VCCIO7	7			VCCIO7	7			
N3	VCCIO7	7			VCCIO7	7			
P10	VCCIO7	7			VCCIO7	7			
R6	VCCIO7	7			VCCIO7	7			
AA25	VCCIO8	8			VCCIO8	8			
AD28	VCCIO8	8			VCCIO8	8			
AA10	VCCAUX	-			VCCAUX	-			
AA11	VCCAUX	-			VCCAUX	-			
AA20	VCCAUX	-			VCCAUX	-			
AA21	VCCAUX	-			VCCAUX	-			
K10	VCCAUX	-			VCCAUX	-			
K11	VCCAUX	-			VCCAUX	-			
K20	VCCAUX	-			VCCAUX	-			
K21	VCCAUX	-			VCCAUX	-			
L10	VCCAUX	-			VCCAUX	-			
L11	VCCAUX	-			VCCAUX	-			
L20	VCCAUX	-			VCCAUX	-			
L21	VCCAUX	-			VCCAUX	-			
Y10	VCCAUX	-			VCCAUX	-			
Y11	VCCAUX	-			VCCAUX	-			
Y20	VCCAUX	-			VCCAUX	-			
Y21	VCCAUX	-			VCCAUX	-			
A1	GND	-			GND	-			
A13	GND	-			GND	-			
A18	GND	-			GND	-			
A24	GND	-			GND	-			
A30	GND	-			GND	-			
A7	GND	-			GND	-			
AA14	GND	-			GND	-			
AA15	GND	-			GND	-			
AA16	GND	-			GND	-			
AA17	GND	-			GND	-			
AA24	GND	-			GND	-			
AA27	GND	-			GND	-			
AA4	GND	-			GND	-			
AB24	GND	-			GND	-			
AB7	GND	-			GND	-			
AD12	GND	-			GND	-			
AD19	GND	-			GND	-			
AD27	GND	-			GND	-			
AE22	GND	-			GND	-			
AE27	GND	-			GND	-			
AE4	GND	-			GND	-			
AE9	GND	-			GND	-			
AF14	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AA1	PL81A	6	LDQS81	T (LVDS)*
GNDIO	GNDIO6	-		
AA2	PL81B	6	LDQ81	C (LVDS)*
Y3	PL82A	6	LDQ81	T
AB1	PL82B	6	LDQ81	C
VCCIO	VCCIO6	6		
Y9	PL83A	6	LDQ81	T (LVDS)*
Y8	PL83B	6	LDQ81	C (LVDS)*
Y7	PL84A	6	LDQ81	T
AA7	PL84B	6	LDQ81	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
AB2	PL95A	6	LDQ99	T (LVDS)*
AB3	PL95B	6	LDQ99	C (LVDS)*
AA5	PL96A	6	LDQ99	T
AA6	PL96B	6	LDQ99	C
AB4	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6		
AB5	PL97B	6	LDQ99	C (LVDS)*
AA8	PL98A	6	LDQ99	T
AA9	PL98B	6	LDQ99	C
AC1	PL99A	6	LLM0_GPLL_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-		
AC2	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AC4	PL100A	6	LLM0_GPLLFB_A/ LDQ99	T
AC3	PL100B	6	LLM0_GPLLC_FB_A/ LDQ99	C
VCCIO	VCCIO6	6		
AC7	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AC6	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AC5	PL102A	6	LLM0_GDLLT_FB_A/ LDQ99	T
AD3	PL102B	6	LLM0_GDLLC_FB_A/ LDQ99	C
GNDIO	GNDIO6	-		
AB8	LLM0_PLLCAP	6		
AD2	PL104A	6		T
AD1	PL104B	6		C
AE2	TCK	-		
AE1	TDI	-		
AF2	TMS	-		
AF1	TDO	-		
AG1	VCCJ	-		
AH1	LLC_SQ_VCCRX3	14		
AK2	LLC_SQ_HDINP3	14		T
AJ1	LLC_SQ_VCCIB3	14		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ2	LLC_SQ_HDINN3	14		C
AH4	LLC_SQ_VCCTX3	14		
AK5	LLC_SQ_HDOUTP3	14		T
AK4	LLC_SQ_VCCOB3	14		
AJ5	LLC_SQ_HDOUTN3	14		C
AH5	LLC_SQ_VCCTX2	14		
AJ6	LLC_SQ_HDOUTN2	14		C
AH6	LLC_SQ_VCCOB2	14		
AK6	LLC_SQ_HDOUTP2	14		T
AH2	LLC_SQ_VCCRX2	14		
AJ3	LLC_SQ_HDINN2	14		C
AH3	LLC_SQ_VCCIB2	14		
AK3	LLC_SQ_HDINP2	14		T
AH7	LLC_SQ_VCCP	14		
AG7	LLC_SQ_REFCLKP	14		T
AF7	LLC_SQ_REFCLKN	14		C
AJ7	LLC_SQ_VCCAUX33	14		
AK11	LLC_SQ_HDINP1	14		T
AH11	LLC_SQ_VCCIB1	14		
AJ11	LLC_SQ_HDINN1	14		C
AH12	LLC_SQ_VCCRX1	14		
AK8	LLC_SQ_HDOUTP1	14		T
AH8	LLC_SQ_VCCOB1	14		
AJ8	LLC_SQ_HDOUTN1	14		C
AH9	LLC_SQ_VCCTX1	14		
AJ9	LLC_SQ_HDOUTN0	14		C
AK10	LLC_SQ_VCCOB0	14		
AK9	LLC_SQ_HDOUTP0	14		T
AH10	LLC_SQ_VCCTX0	14		
AJ12	LLC_SQ_HDINN0	14		C
AJ13	LLC_SQ_VCCIB0	14		
AK12	LLC_SQ_HDINP0	14		T
AH13	LLC_SQ_VCCRX0	14		
AF10	PB30A	5	BDQ33	T
AE8	PB30B	5	BDQ33	C
AE11	PB31A	5	BDQ33	T
VCCIO	VCCI05	5		
AD9	PB31B	5	BDQ33	C
AE10	PB32A	5	BDQ33	T
AD10	PB32B	5	BDQ33	C
AE13	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-		
AC12	PB33B	5	BDQ33	C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D19	PT93B	1		C
E18	PT93A	1		T
D18	PT92B	1		C
C17	PT92A	1		T
A17	PT91B	1		C
B17	PT91A	1		T
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
J18	PT75B	1		C
J19	PT75A	1		T
H17	PT74B	1		C
J17	PT74A	1		T
F18	PT73B	1		C
F17	PT73A	1		T
GNDIO	GNDIO1	-		
A16	PT72B	1		C
B16	PT72A	1		T
G17	PT71B	1		C
G16	PT71A	1		T
VCCIO	VCCIO1	1		
H16	PT70B	1		C
F16	PT70A	1		T
J16	PT69B	1		C
G15	PT69A	1		T
GNDIO	GNDIO1	-		
C16	PT68B	1		C
D16	PT68A	1		T
J15	PT67B	1		C
H15	PT67A	1		T
VCCIO	VCCIO1	1		
A15	PT66B	1	VREF2_1	C
B15	PT66A	1	VREF1_1	T
F15	PT65B	1	PCLKC1_0	C
E16	PT65A	1	PCLKT1_0	T
C15	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
D15	PT64A	0	PCLKT0_0	T
C14	PT63B	0	VREF2_0	C
E15	PT63A	0	VREF1_0	T
G14	PT62B	0		C
VCCIO	VCCIO0	0		
J14	PT62A	0		T
F14	PT61B	0		C



Ordering Information
LatticeECP2/M Family Data Sheet

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100



Ordering Information
LatticeECP2/M Family Data Sheet

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5FN484I	304	1.2V	-5	Lead-Free fpBGA	484	Ind	20
LFE2M20SE-6FN484I	304	1.2V	-6	Lead-Free fpBGA	484	Ind	20
LFE2M20SE-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	Ind	20
LFE2M20SE-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5FN672I	410	1.2V	-5	Lead-Free fpBGA	672	Ind	35
LFE2M35SE-6FN672I	410	1.2V	-6	Lead-Free fpBGA	672	Ind	35
LFE2M35SE-5FN484I	303	1.2V	-5	Lead-Free fpBGA	484	Ind	35
LFE2M35SE-6FN484I	303	1.2V	-6	Lead-Free fpBGA	484	Ind	35
LFE2M35SE-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	Ind	35
LFE2M35SE-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5FN900I	410	1.2V	-5	Lead-Free fpBGA	900	Ind	50
LFE2M50SE-6FN900I	410	1.2V	-6	Lead-Free fpBGA	900	Ind	50
LFE2M50SE-5FN672I	372	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2M50SE-6FN672I	372	1.2V	-6	Lead-Free fpBGA	672	Ind	50
LFE2M50SE-5FN484I	270	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2M50SE-6FN484I	270	1.2V	-6	Lead-Free fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5FN1152I	436	1.2V	-5	Lead-Free fpBGA	1152	Ind	70
LFE2M70SE-6FN1152I	436	1.2V	-6	Lead-Free fpBGA	1152	Ind	70
LFE2M70SE-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2M70SE-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152I	520	1.2V	-5	Lead-Free fpBGA	1152	Ind	100
LFE2M100SE-6FN1152I	520	1.2V	-6	Lead-Free fpBGA	1152	Ind	100
LFE2M100SE-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	100
LFE2M100SE-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	100